## SAMSUNG

## Samsung M386B4G70BM0-YH9 memory module 32 GB 2 x 16 GB DDR3 1600 MHz ECC

**Brand :** Samsung **Product code:** M386B4G70BM0-YH9

Product name: M386B4G70BM0-YH9

32GB, DDR3, 1600 MHz, ECC. CL11

Samsung M386B4G70BM0-YH9 memory module 32 GB 2 x 16 GB DDR3 1600 MHz ECC:

Feel the difference in performance from Samsung's advanced memory technology Samsung's DRAM drives innovation and accelerates performance in various computing solutions, from PCs to servers for advanced AI applications.

Samsung M386B4G70BM0-YH9. Component for: PC/Server, Internal memory: 32 GB, Memory layout (modules x size): 2 x 16 GB, Internal memory type: DDR3, Memory clock speed: 1600 MHz, Memory form

factor: 240-pin DIMM, CAS latency: 11, ECC

Features		Features	
CAS latency	11	Internal memory type *	DDR3
Internal memory *	32 GB	Memory clock speed *	1600 MHz
Memory layout (modules x size) *	2 x 16 GB	Component for *	PC/Server
		Memory form factor *	240-pin DIMM
		ECC *	✓



